

**PATENT ASSIGNMENT**

Electronic Version v1.1  
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<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT								
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT								
<b>CONVEYING PARTY DATA</b>									
<table border="1" style="width:100%; border-collapse: collapse;"> <thead> <tr> <th style="width:70%;">Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>Jiong CHEN</td> <td>06/18/2008</td> </tr> <tr> <td>John D. POLLACK</td> <td>06/18/2008</td> </tr> <tr> <td>Zhimin WAN</td> <td>06/18/2008</td> </tr> </tbody> </table>		Name	Execution Date	Jiong CHEN	06/18/2008	John D. POLLACK	06/18/2008	Zhimin WAN	06/18/2008
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<b>RECEIVING PARTY DATA</b>									
<b>Name:</b>	Advanced Ion Beam Technology								
<b>Street Address:</b>	81 Daggett Drive								
<b>City:</b>	San Jose								
<b>State/Country:</b>	CALIFORNIA								
<b>Postal Code:</b>	95134								
<b>PROPERTY NUMBERS Total: 1</b>									
<table border="1" style="width:100%; border-collapse: collapse;"> <thead> <tr> <th style="width:30%;">Property Type</th> <th>Number</th> </tr> </thead> <tbody> <tr> <td>Application Number:</td> <td>10641219</td> </tr> </tbody> </table>		Property Type	Number	Application Number:	10641219				
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Application Number:	10641219								
<b>CORRESPONDENCE DATA</b>									
<b>Fax Number:</b>	(650)543-2676								
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>									
<b>Phone:</b>	650-493-4540								
<b>Email:</b>	shana@sawyerlawgroup.com								
<b>Correspondent Name:</b>	Joseph A. Sawyer, Jr.								
<b>Address Line 1:</b>	2465 E Bayshore Road, Suite 406								
<b>Address Line 2:</b>	SAWYER LAW GROUP LLP								
<b>Address Line 4:</b>	Palo Alto, CALIFORNIA 94303								
<b>ATTORNEY DOCKET NUMBER:</b>	AIBT-0303/4610P								
<b>NAME OF SUBMITTER:</b>	Joseph A. Sawyer, Jr.								

Total Attachments: 2  
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**PATENT**  
**REEL: 021255 FRAME: 0854**

**OP \$40.00 10641219**



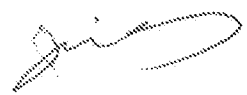

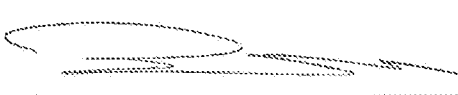
## ASSIGNMENT AGREEMENT

In consideration of One Dollar (\$1.00) and other good and valuable consideration, the receipt of which is hereby acknowledged, we the undersigned (hereinafter, "Assignors"), who, having created a certain invention for which an application for United States Letters Patent entitled: **Apparatus and Method for Reducing Implant Angle Variations Across A Large Wafer for A Batch Disc** for which the application for U.S. Letters Patent has been filed on August 13, 2003 as Application Serial No. 10/641,219, do hereby sell, assign and transfer to Advanced Ion Beam Technology, Inc., having a place of business at 81 Daggett Drive, San Jose, California, their successors, assigns, and legal representatives (hereinafter collectively referred to as "Assignees"), the full and exclusive right to said invention and said application and to any and all inventions described in said application for the United States, its territorial possessions and all foreign countries, and the entire right, title and interest in and to any and all Letters Patent which may be granted therefor in the United States, its territorial possessions and all foreign countries; and in and to any and all continuations-in-part, continuations, divisions, substitutes, reissues, extensions thereof, and all other applications for Letters Patent relating thereto which have been or shall be filed in the United States, its territorial possessions and/or any foreign countries, and all rights, together with all priority rights, under any of the international conventions, unions, agreements, acts, and treaties, including all future conventions, unions, agreements, acts, and treaties;

We authorize Assignees to apply for and receive Letters Patent for such protection in their own names, in the United States, its territorial possessions, and all foreign countries; and that, when requested to carry out in good faith the intent and purpose of this assignment, at the expense of said Assignees, but without charge to Assignees, their successors, assigns and legal representatives, the undersigned will execute all continuations-in-part, continuations, divisions, substitutes, reissues, and extensions thereof, execute all rightful oaths, assignments, powers of attorney and other papers, testify in any legal or quasi legal proceedings; communicate to said Assignees, their successors, assigns, and legal representatives all facts known to the undersigned relating to said invention and the history thereof; and generally do everything possible which said Assignees, their successors, assigns or legal representatives shall consider desirable for aiding in securing, maintaining and enforcing proper patent protection for said invention and for vesting title to said invention and all applications for patents on said invention in said Assignees, their successors, assigns and legal representatives; and

We request the Honorable Commissioner of Patents to issue said Letters Patent to said Assignee; and,

We covenant with said Assignees, their successors, assigns and legal representatives that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

 _____	 _____	 _____
Jiong Chen	John D. Pollack	Zhimin Wan
Date: <u>6/18/08</u>	Date: _____	Date: <u>6/18/08</u>

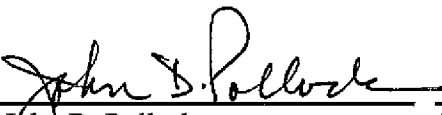
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